

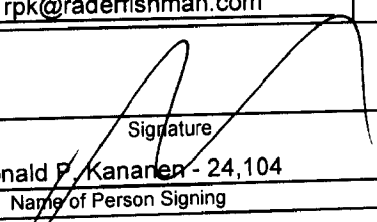


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To the Director of the U.S. Patent and Trademark Office, and to the appropriate Patent Office, if any, of the country of origin of the documents or the new address(es) below.

10-51-07

<b>1. Name of conveying party(ies):</b> Yoshimitsu Funabashi (09/12/2007), Keiko Hiraoka (09/12/2007), Mayu Irimajiri (09/21/2007), Atsushi Imai (09/13/2007), Additional name(s) of conveying party(ies) attached? <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		<b>2. Name and address of receiving party(ies)</b> Name: <u>SONY ERICSSON MOBILE COMMUNICATIONS JAPAN, INC.</u> Internal Address: _____ Street Address: _____ 1-8-15, Konan Minato-Ku, Tokyo JAPAN City: _____ State: _____ Country: _____ Zip: _____ Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
<b>3. Nature of conveyance/Execution Date(s):</b> Execution Date(s): <u>in parentheses after inventor name</u> <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name <input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____		<b>4. Application or patent number(s):</b> <input type="checkbox"/> This document is being filed together with a new application. A. Patent Application No.(s) <u>11/806,547</u> B. Patent No.(s) _____ Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	
<b>5. Name and address to whom correspondence concerning document should be mailed:</b> Name: <u>Ronald P. Kananen</u> <u>RADER, FISHMAN &amp; GRAUER PLLC</u> Internal Address: <u>Atty. Dkt.: SON-3768</u> Street Address: <u>1233 20th Street, N.W.</u> <u>Suite 501</u> City: <u>Washington</u> State: <u>DC</u> Zip: <u>20036</u> Phone Number: <u>(202) 955-3750</u> Fax Number: <u>(202) 955-3751</u> Email Address: <u>rpk@raderfishman.com</u>		<b>6. Total number of applications and patents involved:</b> <span style="border: 1px solid black; padding: 2px;">1</span> <b>7. Total fee (37 CFR 1.21(h) &amp; 3.41)</b> \$ <u>40.00</u> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)	
<b>9. Signature:</b>  _____ Signature <u>Ronald P. Kananen - 24,104</u> Name of Person Signing		<b>8. Payment Information</b> a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <u>18-0013</u> Authorized User Name <u>Ronald P. Kananen</u>	
		Total number of pages including cover sheet, attachments, and documents: <span style="border: 1px solid black; padding: 2px;">8</span>	

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RECORDATION FORM COVER SHEET (PTO-1595)  
(supplemental sheet)

Additional Conveying Party(ies)/Execution Date(s) (1. Continued):

Takamoto Tsuda (09/12/2007), Takeshi Matsuzawa (09/26/2007), Takeshi Tanigawa (09/11/2007),  
Tomoharu Okamoto (09/14/2007), Akihiko Adachi (09/13/2007), and Tatsuhiko Nishimura (09/14/2007)

Additional Assignees (2. Continued):

Assignee Name: \_\_\_\_\_

Internal Address:

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Assignee Name: \_\_\_\_\_

Internal Address:

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Assignee Name: \_\_\_\_\_

Internal Address:

Street Address:

City: \_\_\_\_\_ State: \_\_\_\_\_ Country: \_\_\_\_\_ Zip: \_\_\_\_\_

Additional Applications and/or Patents (4. Continued):

Additional Patent Application Numbers  
4A. Continued:

Additional Patent Numbers  
4B. Continued:

Additional numbers attached?

Yes

No

Docket Number: SON-3768

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

**INFORMATION PROCESSING DEVICE, INFORMATION PROCESSING METHOD,  
INFORMATION PROCESSING PROGRAM, AND PORTABLE TERMINAL DEVICE**

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, **Sony Ericsson Mobile Communications Japan, Inc.**, located and doing business at **1-8-15, Konan, Minato-ku, Tokyo, Japan** (hereinafter referenced as ASSIGNEE) are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES

thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: \_\_\_\_\_, Filing Date: June 1, 2007.

This assignment executed on the dates indicated below.

Yoshimitsu Funabashi

Name of first inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of first inventor

*Yoshimitsu Funabashi*

*Sep 12, 2007*

Signature of first inventor

Date of this assignment

Keiko Hiraoka

Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of second inventor

\_\_\_\_\_  
Signature of second inventor

Date of this assignment

Mayu Irimajiri

Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of Third inventor

\_\_\_\_\_  
Signature of third inventor

Date of this assignment

thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: \_\_\_\_\_, Filing Date: June 1, 2007.

This assignment executed on the dates indicated below.

Yoshimitsu Funabashi  
Name of first inventor

Execution date of U.S. Patent Application

Tokyo, Japan  
Residence of first inventor

\_\_\_\_\_  
Signature of first inventor

Date of this assignment

Keiko Hiraoka  
Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan  
Residence of second inventor

Keiko Hiraoka  
Signature of second inventor

*September 12, 2007*  
Date of this assignment

Mayu Irimajiri  
Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan  
Residence of Third inventor

Mayu Irimajiri  
Signature of third inventor

*Sept. 22, 2007*  
Date of this assignment

Atsushi Imai

Name of fourth inventor

Tokyo, Japan

Residence of fourth inventor

Atsushi Imai

Signature of fourth inventor

Execution date of U.S. Patent Application

September 13, 2007

Date of this assignment

Takamoto Tsuda

Name of fifth inventor

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Residence of fifth inventor

Takamoto Tsuda

Signature of fifth inventor

Execution date of U.S. Patent Application

September 12, 2007

Date of this assignment

Takeshi Matsuzawa

Name of sixth inventor

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Residence of sixth inventor

Takeshi Matsuzawa

Signature of sixth inventor

Execution date of U.S. Patent Application

September 26, 2007

Date of this assignment

Takeshi Tanigawa

Name of seventh inventor

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Residence of seventh inventor

Takeshi Tanigawa

Signature of seventh inventor

Execution date of U.S. Patent Application

September 11, 2007

Date of this assignment

Tomoharu Okamoto

Name of eighth inventor

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Residence of eighth inventor

Execution date of U.S. Patent Application

*Tomonori Ohno*

Signature of eighth inventor

*Sep. 14, 2007*

Date of this assignment

Akihiko Adachi

Name of ninth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of ninth inventor

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Signature of ninth inventor

Date of this assignment

Tatsuhiko Nishimura

Name of tenth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of tenth inventor

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Signature of tenth inventor

Date of this assignment

Signature of eighth inventor

Date of this assignment

Akihiko Adachi

Name of ninth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of ninth inventor

*Sep. 13, 2007*  
~~*Sep. 14, 2007*~~  
*A.A.*

Akihiko Adachi

Signature of ninth inventor

Date of this assignment

Tatsuhiko Nishimura

Name of tenth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of tenth inventor

*14. Sep. 2007*

Tatsuhiko Nishimura

Signature of tenth inventor

Date of this assignment